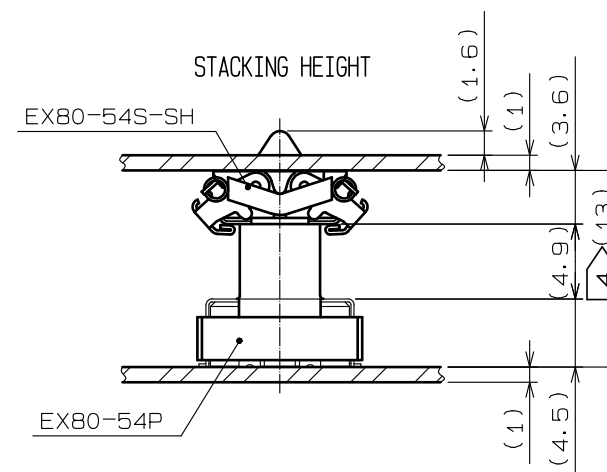
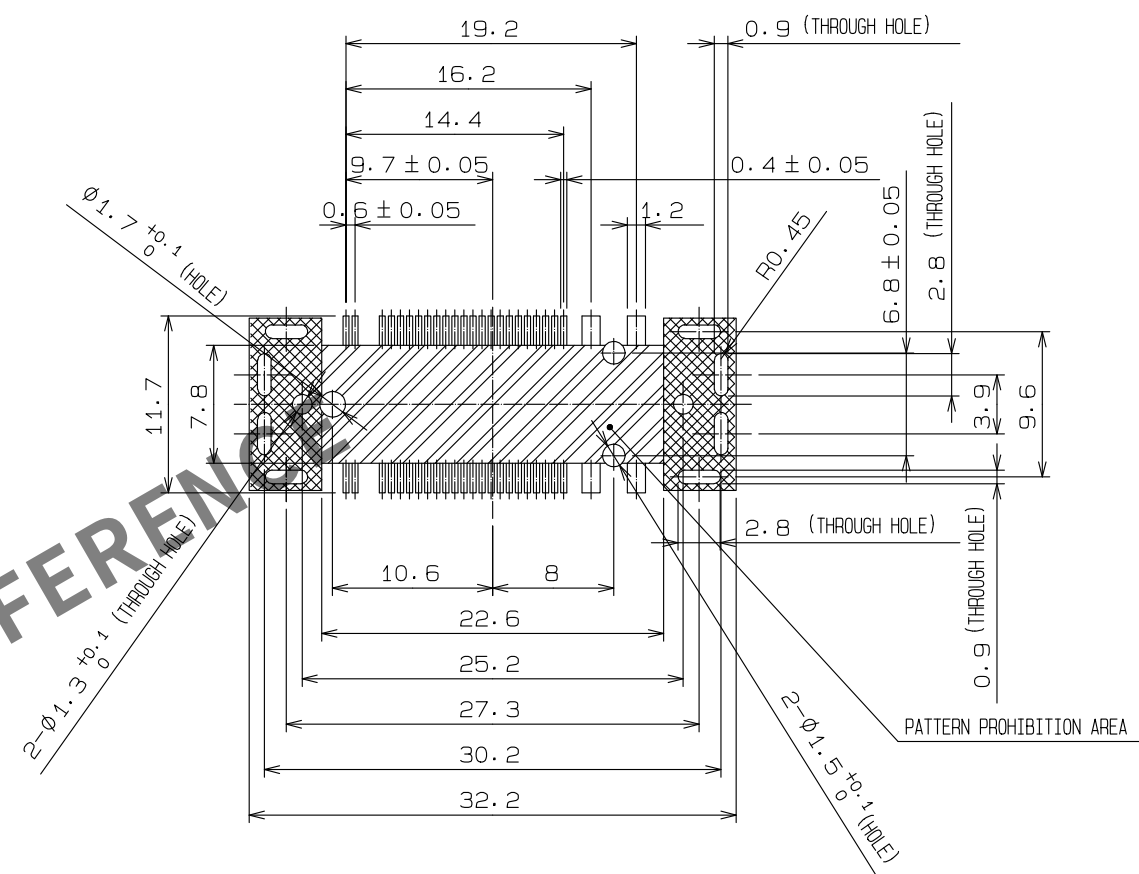
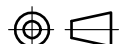


RECOMMENDED PC BOARD PATTERN (AUTOMATIC MOUNTING)

(COMPONENT MOUNTING SIDE : PCB t=1 MIN)



2	Copper Alloy	Contact area:gold plating 0.5# min Lead area:gold plating 0.03# min Under:nickel plating 2# min	7	PS	
1	Copper Alloy	Contact area:gold plating 0.5# min Lead area:gold plating 0.03# min Under:nickel plating 2# min	5	Stainless steel	Dip area:tin plating 1# min Under:nickel plating 0.5# min 
			4	LCP	UL94V-0, Black
			3	Phosphor Bronze	Dip area:gold plating 0.03# min Under:nickel plating 2# min
NO.	MATERIAL	FINISH , REMARKS	NO.	MATERIAL	FINISH , REMARKS

UNITS mm		SCALE 2 : 1	COUNT  1	DESCRIPTION OF REVISIONS DIS-E-00004011	DESIGNED MO. SHIMOYAMA	CHECKED TU. TANIGUCHI	DATE 20210120
 HIROSE ELECTRIC CO., LTD.		APPROVED :MN. KENJO	20200407	DRAWING NO. EDC-123447-70-00			
		CHECKED :TU. TANIGUCHI	20200407	PART NO. EX80-54(50)P(70)			
		DESIGNED :KIM JAEHYEON	20200407	CODE NO. CL0232-0607-8-70			
		DRAWN :DS. HIROWATARI	20200407	 1/1			

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EX80-54P PACKAGING FIGURE

